

**memorix elektronik**  
**PCMCIA / JEIDA SRAM CARD 8 Bit Data Bus**

**Contents**

- 1. FEATURES**
- 2. GENERAL DESCRIPTION**
- 3. PRODUCT NUMBER DEFINITION**
- 4. PRODUCT LIST**
- 5. RECOMMENDED OPERATING CONDITIONS**
- 6. DC ELECTRICAL CONDITIONS**
- 11. AC ELECTRICAL CHARACTERISTICS**
- 15. MAIN BATTERY SPECIFICATION**

## **memorix elektronik**

### **PCMCIA / JEIDA SRAM CARD 8Bit**

#### **Features**

- ★ PCMCIA / JEIDA standard
- ★ Dual back-up battery design
- ★ 1 Mbytes ~ 8 Mbytes memory capacity
- ★ BR2325 and CR2025 used as main battery
- ★ **8 Bit data bus**
- ★ Battery voltage detection function
- ★ Fast access time : 150ns (maximum)
- ★ Built-in write protect switch
- ★ Attribute memory : 2K byte E2PROM
- ★ Battery case lock system
- ★ Connector type : 2-piece,2-row,68 pins
- ★ Single +5V operating voltage
- ★ Credit card size : 54.0 x 85.6 x 3.3 (mm)
- ★ Commercial / Industrial grade

#### **General Description**

memorix high performance SRAM cards conform to the PCMCIA / JEIDA international standard and consist of multiple very low power consumption CMOS SRAM ICs , decoder IC and power control IC mounted on a very thin printed circuit board using surface mounting technology. With the dual back-up battery design , each SRAM card contains a replaceable but non-rechargeable 3V lithium battery (main battery) and an on-board rechargeable but non-replaceable battery (auxiliary battery) for data retention. This design allows replacement of main battery without data loss for 20 minutes approximately. Digital signals on the BVD1\*/BVD2\* pins were used to alarm the user whether the main battery should be replaced to prevent the stored data from loss. With the flexible and user-friendly design , both BR2325 and CR2025 can be used as main battery. There is battery case lock system to prevent battery dropping from the card. Also , with the write-protect switch design , data will not be written into the card by accident. Memory card attribute information represents various attribute information of a card and is stored at EVEN address of a “ attribute memory” space which is enabled by asserting REG\* signal. Regarding to the attribute information format , please refer to the PCMCIA 2.0 or JEIDA 4.1 specification. With the flexible design of this series cards , they provide 2K bytes E2PROM available for attribute memory

## **memorix elektronik**

### **Product Number Definition**

#### **Product Number**

**SC001M-15C-00-A002K-8bit**

**SC SRAM Card**

**001M 1 Mbyte Capacity**

**15 Access time (150 ns)**

**C Common temperature range 0° C ~70 ° C**

**I Industrial Temperaturerange -25° C ~ +70° C**

**A002K (optional) Attribut memory 2Kbyte**

**8 Bit Data Bus**

### **Product List**

#### **SRAM Cards**

SC001M-15C-00-A002K-8bit

SC002M-15C-00-A002K-8bit

SC004M-15C-00-A002K-8bit

SC008M-15C-00-A002K-8bit

**Commercial Temperature Range 0° C ~70 ° C**

### **Product List**

#### **SRAM Cards**

SC001M-15I-00-A002K-8bit

SC002M-15I-00-A002K-8bit

SC004M-15I-00-A002K-8bit

SC008M-15I-00-A002K-8bit

**Industrial Temperature Range -25° C ~ +75° C**

## Recommended Operating Conditions

Supply Voltage VCC 4.5 5.5 V

Input High Voltage VIH 0.7VCC VCC + 0.3 V

Input Low Voltage VIL - 0.3 0.8 V

Battery Voltage VBAT 2.37 V

Relative Humidity (non-condensing) HUM 95 %

### Absolute Maximum Ratings \*

Parameter Symbol Value Unit

Supply Voltage VCC -0.5 to + 6.0 V

Input Voltage VIN -0.5 to VCC + 0.3 (6V max.) V

Output Voltage VOUT -0.5 to + 6.0 V

Operating Temperature ( Commercial ) TOPR -0 to + 70 °C

Storage Temperature ( Commercial ) TSTR -25 to + 70 °C

Operating Temperature ( Industrial ) TOPR -25 to + 75 °C

Storage Temperature( Industrial ) TSTR -40 to + 85 °C

Relative Humidity (non-condensing) HUM 95 (maximum) %

### \*Comments

Stress above those listed under " Absolute Maximum Ratings " may cause permanent damage to the products. These are stress rating only. Functional operation of these products at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

## DC Electrical Characteristics

(recommended operating conditions unless otherwise noted)

Symbol Parameter Min. Max. Unit Test Conditions

I<sub>LI</sub> Input Leakage Current -10 10 uA V<sub>IN</sub> = 0V to V<sub>CC</sub> ( Note 3 )

-70 10 uA V<sub>IN</sub> = 0V to V<sub>CC</sub> ( Note 4 )

I<sub>LO</sub> Output Leakage Current -10 10 uA CE1\* = CE2\* = V<sub>IH</sub> or OE\* = V<sub>IH</sub> ,  
V<sub>I/O</sub> = 0V to V<sub>CC</sub> ( Note 1 )

V<sub>OH</sub> Output High Voltage 3.8 V I<sub>OH</sub> = -2mA (Note 2)

V<sub>OL</sub> Output Low Voltage 0.4 V I<sub>OL</sub> = 3.2mA ( Note 2 )

V<sub>IH</sub> Input High Voltage 0.7V<sub>CC</sub> V<sub>CC</sub>+0.3 V

V<sub>IL</sub> Input Low Voltage -0.3 0.3V<sub>CC</sub> V

I<sub>CC</sub> V<sub>CC</sub> Operating Current 120 mA Min. cycle , I<sub>Out</sub> = 0mA

I<sub>SB</sub> V<sub>CC</sub> Standby Current 0.1 mA For page 3 & 4, item 9

( CE1\* = CE2\* = V<sub>IH</sub> or 0.2 mA For page 3 & 4, item 10

CE1\* = CE2\* ≥ V<sub>CC</sub> - 0.2V ) 0.1 mA For page 3 & 4, item 11,17

## AC Electrical Characteristics ( Common Memory )

( recommended operating conditions unless otherwise noted )

### Read Cycle ( Common Memory )

Symbol Parameter Min. Max. Unit Test Condition

$t_{cr}$  Read Cycle Time 150 ns

$t_{a(A)}$  Address Access Time 150 ns

$t_{a(CE)}$  Card Enable Access Time 150 ns

$t_{a(OE)}$  Output Enable Access Time 75 ns

$t_{dis(CE)}$  Output Disable Time (CE\*) 75 ns

$t_{dis(OE)}$  Output Disable Time (OE\*) 75 ns

$t_{en(CE)}$  Output Enable Time (CE\*) 5 ns

$t_{en(OE)}$  Output Enable Time (OE\*) 5 ns

$t_{v(A)}$  Data Hold Time (from address changed) 0 ns

### Write Cycle ( Common Memory )

Symbol Parameter Min. Max Unit Test Condition

$t_{cw}$  Write Cycle Time 150 ns

$t_{w(WE)}$  Write Pulse Width 80 ns

$t_{su(A)}$  Address Setup Time 20 ns

$t_{su(A-WEH)}$  Address Setup Time (WE\*) 100 ns

$t_{su(CE-WEH)}$  CE\* Setup Time (WE\*) 100 ns

$t_{su(D-WEH)}$  Data Setup Time (WE\*) 50 ns

$t_{h(D)}$  Data Hold Time 20 ns

$t_{rec(WE)}$  Write Recovery Time 20 ns

$t_{dis(WE)}$  Output Disable Time (WE\*) 75 ns

$t_{dis(OE)}$  Output Disable Time (OE\*) 75 ns

$t_{en(WE)}$  Output Enable Time (WE\*) 5 ns

$t_{en(OE)}$  Output Enable Time (OE\*) 5 ns

$t_{en(OE-WE)}$  Output Enable Setup Time (WE\*) 10 ns

$t_{h(OE-WE)}$  Output Enable Hold Time (WE\*) 10 ns

## AC Electrical Characteristics ( Attribute Memory )

( recommended operating conditions unless otherwise noted )

### Read Cycle ( Attribute Memory )

Symbol Parameter Min. Max Unit Test Condition

$t_{cr}$  Read Cycle Time 300 ns

$t_{a(A)}$  Address Access Time 300 ns

$t_{a(CE)}$  Card Select Access Time 300 ns

$t_{a(OE)}$  Output Enable Access Time 150 ns

$t_{dis(CE)}$  Output Disable Time (from CE\*) 100 ns

$t_{dis(OE)}$  Output Disable Time (from OE\*) 100 ns

$t_{en(CE)}$  Output Enable Time (from CE\*) 5 ns

$t_{en(OE)}$  Output Enable Time (from OE\*) 5 ns

$t_{v(A)}$  Data Hold Time (from address changed) 0 ns

### **Write Cycle ( Attribute Memory )**

Symbol Parameter Min. Max. Unit Test Condition

tCW Write Cycle Time 1 ms

tAS Address Setup Time 30 ns

tAH Address Hold Time 50 ns

tWP Write Pulse Width 120 ns

tCS Card Enable Time to WE\* 15 ns

tCH Card Enable Hold Time from WE\* High 0 ns

tDS Data Setup Time 70 ns

tDH Data Hold Time 30 ns

tOES OE\* Setup Time 30 ns

tOEH OE\* Hold Time 30 ns

tDB Delay from WE\* high to BUSY\* Asserted 50 ns

### **Battery Voltage Detection**

BVD1\*/BVD2\* pins are used to monitor the voltage of the main battery which should be maintained at 2.65V or greater for data retention. The following table described the main battery status by reading the signals on

BVD1\*/BVD2\* pins.

BVD1\* BVD2\* Main Battery Comments

H H  $V_{BAT} \geq 2.65V$  Data retention is OK. Battery is operational

H L  $2.37V < V_{BAT} < 2.65V$  Data retention is OK. But battery should be replaced.

L L  $V_{BAT} < 2.37V$  Data integrity is not guaranteed.

Battery must be replaced.

Note : if the main battery is removed , BVD1\* and BVD2\* pins will not function

### **Main Battery Specifications**

■ 3V Lithium battery

■ Recommended parts .

RAYOVAC BR2325

TOSHIBA CR2025

PANASONIC BR2325

PANASONIC CR2025

### **Approximate Battery Life Time Under Battery Back-up Only**

(  $T_a=25^{\circ}C$ , Humidity=60% R.H. )

Product Part No. Battery Life Product Part No. Battery Life

SC001M-15C-00-A002K-8bit 3,5 years SC001M-15I-00-A002K-8bit 3,0 years

SC002M-15C-00-A002K-8bit 1,5 years SC002M-15I-00-A002K-8bit 1,0 years

SC004M-15C-00-A002K-8bit 1,0 years SC004M-15I-00-A002K-8bit 0,5 years

SC008M-15C-00-A002K-8bit 0,5 years SC006M-15I-00-A002K-8bit 0,5 years